

### **Description**

The TD101X series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon planar phototransistor detector in a plastic LSOP4 package.

With the robust coplanar double mold structure,

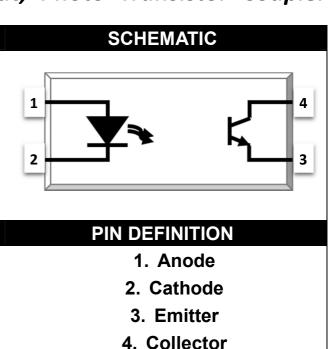
With the robust coplanar double mold structure, TD101X series provide the most stable isolation feature.

#### **Features**

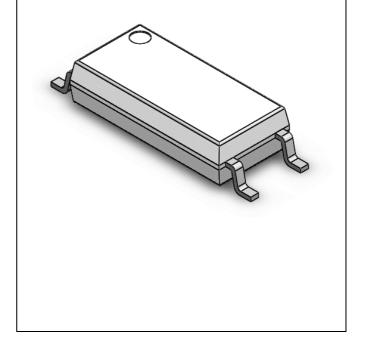
- High isolation 5000 VRMS
- CTR flexibility available see order information
- DC input with transistor output
- Operating temperature range 55 °C to 110 °C
- RoHS & REACH Compliance
- MSL class 1
- Regulatory Approvals
  - UL UL1577
  - VDE EN60747-5-5(VDE0884-5)
  - CQC GB4943.1, GB8898

## **Applications**

- Switch mode power supplies
- Programmable controllers
- Household appliances
- Office equipment









ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	VALUE	UNIT	NOTE			
INPUT							
Forward Current	lF	60	mA				
Peak Forward Current	IFP	1	Α	1			
Reverse Voltage	VR	6	V				
Input Power Dissipation	Pı	100	mW				
OUTPUT							
Collector - Emitter Voltage	V <sub>CEO</sub>	80	V				
Emitter - Collector Voltage	VECO	7	V				
Collector Current	lc	50	mA				
Output Power Dissipation	Po	150	mW				
COMMON							
Total Power Dissipation	Ptot	250	mW				
Isolation Voltage	Viso	5000	Vrms	2			
Operating Temperature	Topr	-55~110	°C				
Storage Temperature	Tstg	-55~125	°C				
Soldering Temperature	Tsol	260	°C				

Note 1. 100µs pulse, 100Hz frequency

Note 2. AC For 1 Minute, R.H. =  $40 \sim 60\%$ 



	ELECT	RICAL OF	PTICA	L CHA	ARAC	TER	ISTICS at Ta=25°C	
PARAM	ETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
INPUT								
Forward \	√oltage	VF	-	1.24	1.4	V	I <sub>F</sub> =10mA	
Reverse	Reverse Current		-	-	10	μA	V <sub>R</sub> =6V	
Input Capa	acitance	Cin	-	30	250	pF	V=0, f=1kHz	
			OUTPUT					
Collector Da	rk Current	Iceo	-	ı	100	nA	V <sub>CE</sub> =20V, I <sub>F</sub> =0	
Collector-	Collector-Emitter		80		V	1 =0.4 == 0.1 =0		
Breakdowr	n Voltage	BV <sub>CEO</sub>	00	_	_	V	I <sub>C</sub> =0.1mA, I <sub>F</sub> =0	
Emitter-C	ollector	BVECO	7	_	_	V	I <sub>E</sub> =0.1mA, I <sub>F</sub> =0	
Breakdowr	n Voltage	DVECO	<i>'</i>	_	_	V	IE-0. IIIIA, IF-0	
		TR	ANSFE	R CHA	RACT	FERIS	TICS	_
	TD1010		300	-	600			
	TD1015		50	-	150			
	TD1016		100	-	300		I <sub>F</sub> =5mA, V <sub>CE</sub> =5V	
	TD1017		80	-	160			
	TD1018		130	-	260			
Current	TD1019		200	-	400			
Transfer	TD1011	CTR	60	-	300	%		
Ratio	TD1012		63	-	125		I <sub>F</sub> =10mA, V <sub>CE</sub> =5V	
TD1	TD1013		100	-	200		IF-TOITIM, VCE-5V	
	TD1014		160	-	320			
	TD1012		22	-	-			
	TD1013		34	-	-		I <sub>F</sub> =1mA, V <sub>CE</sub> =5V	
	TD1014		56	-	-			
Collector-	Emitter	V <sub>CE(sat)</sub>	_	0.1	0.3	V	l⊧=10mA, lc=1mA	
Saturation Voltage		v o⊏(sai)		0.1	0.0	•	11 1011111, 10 111111	
	Isolation Resistance		10^12	10^14	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Capacitance		Сю	-	0.4	1	pF	V=0, f=1MHz	
Cut-off Frequency		Fc	Fc -	80	_	kHz	V <sub>CE</sub> =2V, I <sub>C</sub> =2mA	3
							R <sub>L</sub> =100Ω,-3dB	
Response Time (Rise)			-	5	18	μs	V <sub>CE</sub> =2V, I <sub>C</sub> =2mA	4
Response Time (Fall)		Tf	-	6	18	μs	R <sub>L</sub> =100Ω	4

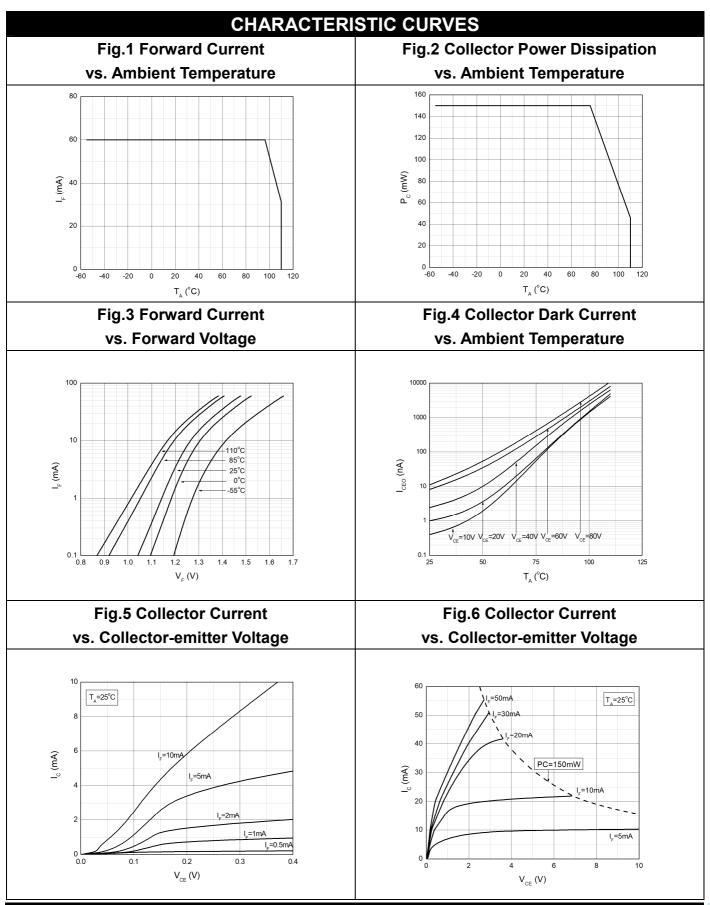
Note 3. Fig.12&13

Note 4. Fig.14



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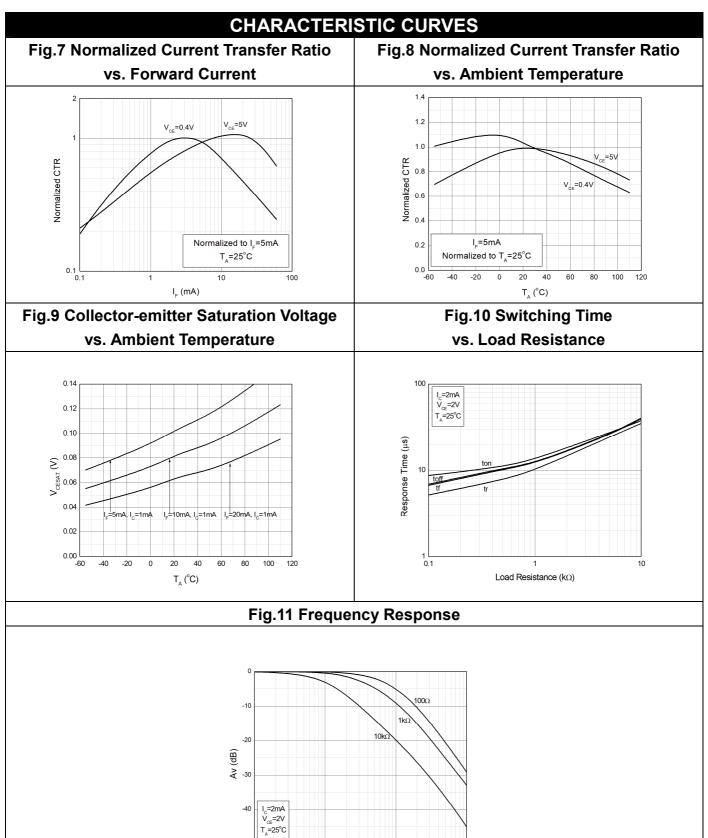
# LSOP4, DC Input, Photo Transistor Coupler



Rev: A03

Release Date: 2020/1/20

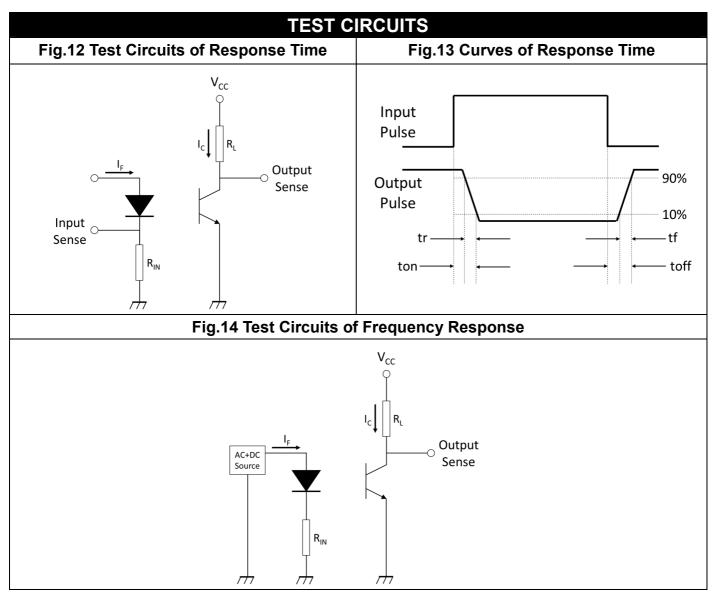




Document No: DWI002 Rev: A03 Release Date: 2020/1/20

f (kHz)

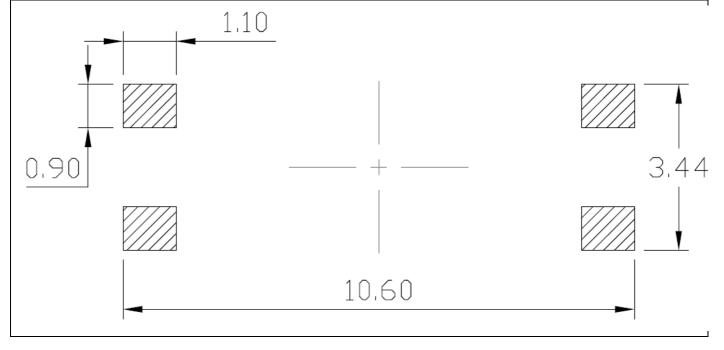






## PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated) 11 1.1 3.60±0.20 7.60±0.20 8.50±0.30 2.00±0.10 Typ.0.20 Typ.2.10 Typ.0.10 Тур.0.40 Typ.0.50 Typ.2.54 10.20±0.30

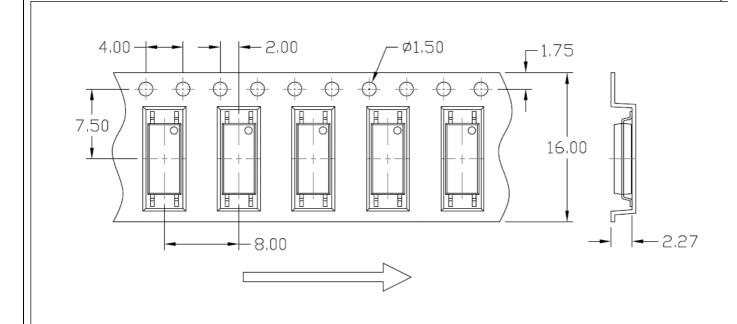
## RECOMMENDED SOLDER MASK (Dimensions in mm unless otherwise stated)



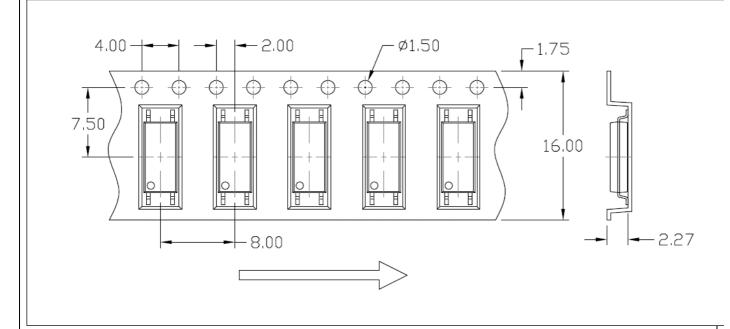


## CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

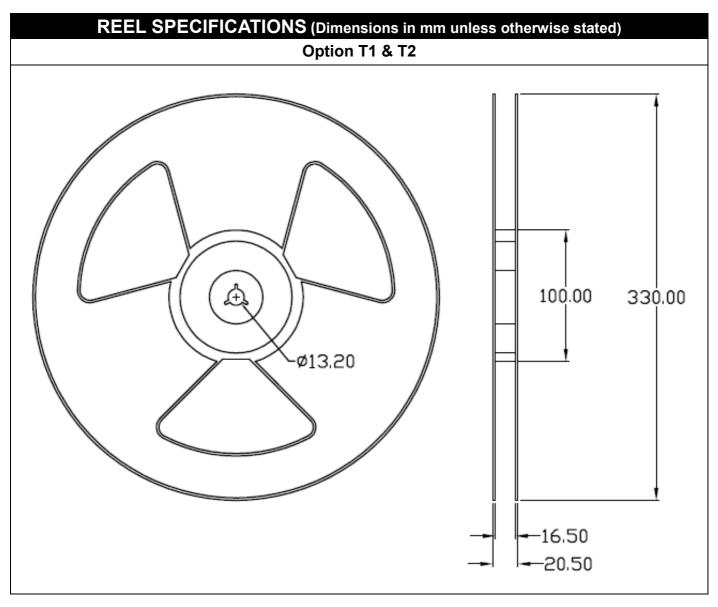
## **Option T1**



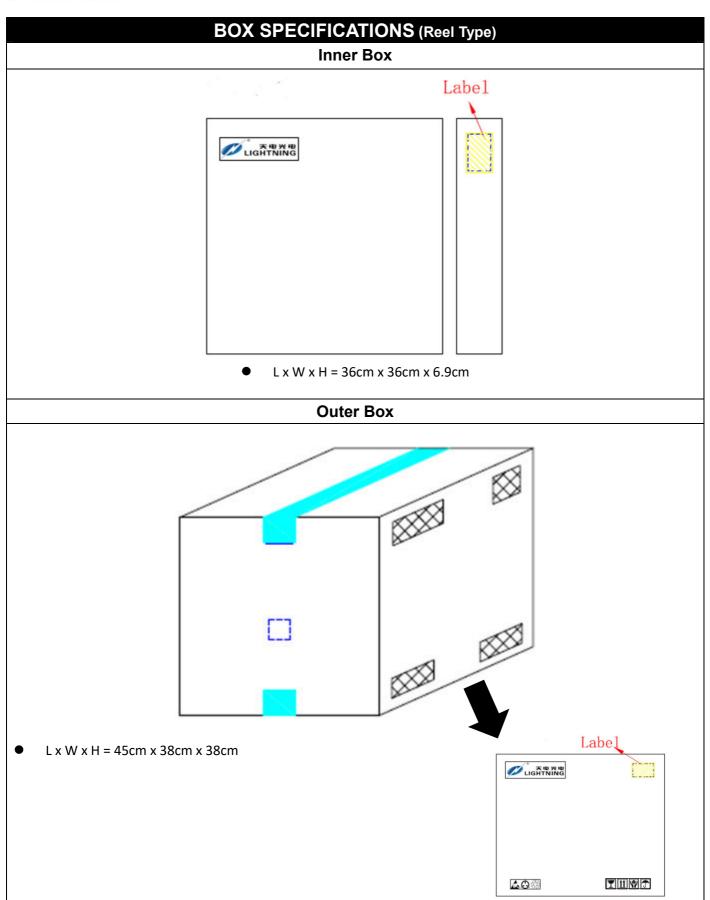
## **Option T2**













## **ORDERING AND MARKING INFORMATION**

### **MARKING INFORMATION**



TD: Company Abbr.

101X : Part Number & Rank

V : VDE Option Y : Fiscal Year

A : Manufacturing Code

WW : Work Week

#### **ORDERING INFORMATION**

## **TD101X(Z)-GV**

TD - Company Abbr.

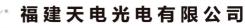
101X - Rank (0/1/2/3/4/5/6/7/8/9)

Z – Tape and Reel Option (T1/T2)

G – Green

V – VDE Option (V or None)

### LABEL INFORMATION



THING FUJIAN LIGHTNING OPTOELECTRONIC CO., LTD.

Part No: XXXXXXXXXXXXX Bin Code: X



Lot No: XXXXXXXXXX

Date Code : XXXX Q'ty : XXXX pcs



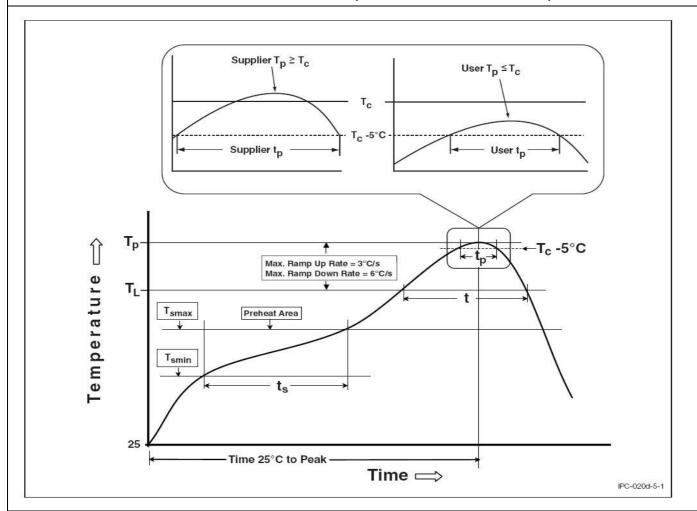


### **PACKING QUANTITY**

Option	Quantity	Quantity – Inner box	Quantity – Outer box	
T1	3000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 45k Units	
T2	3000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 45k Units	

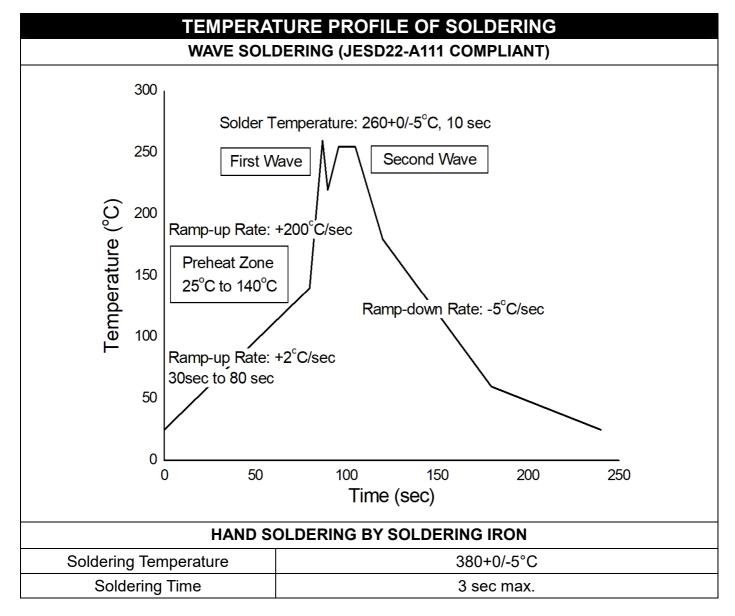


# TEMPERATURE PROFILE OF SOLDERING IR REFLOW SOLDERING (J-STD-020D COMPLIANT)



Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	100	150°C
Temperature Max. (Tsmax)	150	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	60-120 seconds
Ramp-up Rate (tL to tP)	3°C/second max.	3°C/second max.
Liquidous Temperature (TL)	183°C	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (tP) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.





Note 5. One time soldering is recommended for all soldering method.

Note 6. Do not solder more than three times for IR reflow soldering.



### **DISCLAIMER**

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- The characteristic curves shown in this datasheet are representing typical performance which are not guaranteed.
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- This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or lifesaving applications or any other application which can result in human injury or death.
- Please contact LIGHTNING sales agent for special application request.
- Immerge unit's body in solder paste is not recommended.
- Parameters provided in datasheets may vary in different applications and performance may vary
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  customer application by the customer's technical experts. Product specifications do not expand or
  otherwise modify LIGHTNING's terms and conditions of purchase, including but not limited to the
  warranty expressed therein.
- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.